

### ECMF04-4HSWM10

# Common-mode filter with ESD protection for high-speed serial interfaces

Datasheet - production data

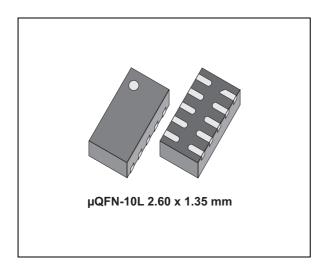
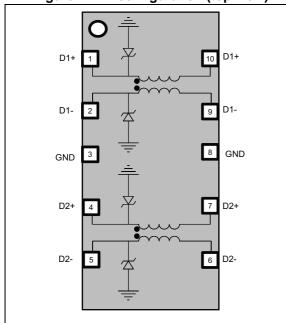


Figure 1. Pin configuration (top view)



#### **Features**

- Very large differential bandwidth to comply with HDMI 2.0, USB3.0, MIPI, DisplayPort and other high speed serial interfaces
- High common mode attenuation on WLAN frequencies:
  - 28 dB at 2.4 GHz and -16 dB at 5.0 GHz
- Very good attenuation at LTE, GSM and GPS frequencies
- Large bandwidth: 4.2GHz
- Very low PCB space consumption
- Thin package: 0.55 mm max.
- · Lead-free package
- High reduction of parasitic elements through integration

#### Complies with the following standards:

- IEC 61000-4-2 level 4:
  - ±15 kV (air discharge)
  - ±8 kV (contact discharge)

### **Applications**

- Set top box
- Streaming box
- Game console
- Notebook, laptop
- Portable devices

### Description

The ECMF04-4HSWM10 is a highly integrated common-mode filter designed to suppress EMI/RFI common mode noise on high-speed differential serial buses like HDMI 2.0, USB3.0, Ethernet, MIPI, DisplayPort and other high-speed serial interfaces. The device has a very large differential bandwidth to comply with these standards and can also protect and filter 2 differential lanes.

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ECMF04-4HSWM10 Characteristics

# 1 Characteristics

Table 1. Absolute maximum ratings ( $T_{amb} = 25 \text{ °C}$ )

Symbol	Par	Value	Unit	
V <sub>PP</sub>	Peak pulse voltage	IEC 61000-4-2 Contact discharge (connector side) Air discharge (connector side)	8 15	kV
I <sub>RMS</sub>	Maximum RMS current	100	mA	
T <sub>op</sub>	Operating temperature range	-40 to +85	°C	
Tj	Maximum junction temperature	125	°C	
T <sub>stg</sub>	Storage temperature range	- 55 to +150	°C	

Figure 2. Electrical characteristics (definitions)

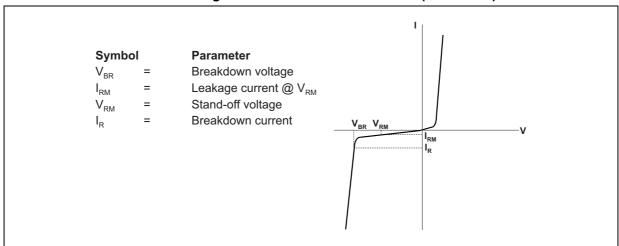


Table 2. Electrical characteristics (T<sub>amb</sub> = 25 °C)

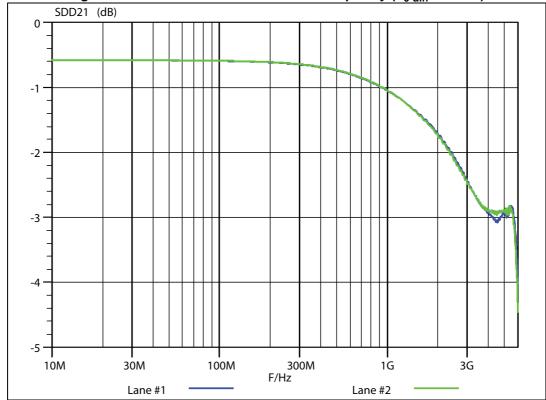
Symbol	Test conditions	Min.	Тур.	Max.	Unit
$V_{BR}$	I <sub>R</sub> = 1 mA	4.5	5.5		V
I <sub>RM</sub>	V <sub>RM</sub> = 3 V per line			100	nA
R <sub>DC</sub>	DC serial resistance		5		Ω
F <sub>C</sub>	-3dB differential mode cut-off frequency		4.2		GHz

Characteristics ECMF04-4HSWM10

Table 3. Pin description

Pin number	Description	Pin number	Description
1	D1+ to connector	6	D2- to IC
2	D1- to connector	7	D2+ to IC
3	GND	8	GND
4	D2+ to connector	9	D1- to IC
5	D2- to connector	10	D1+ to IC





ECMF04-4HSWM10 **Characteristics** 

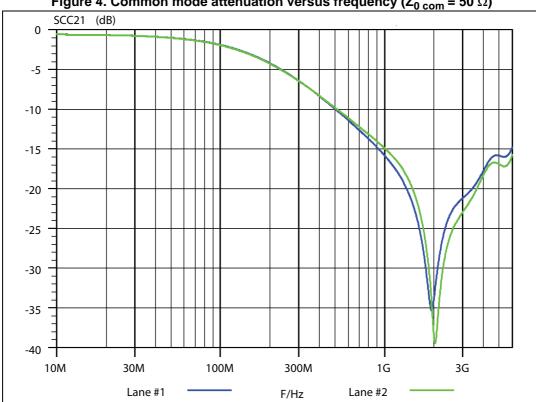
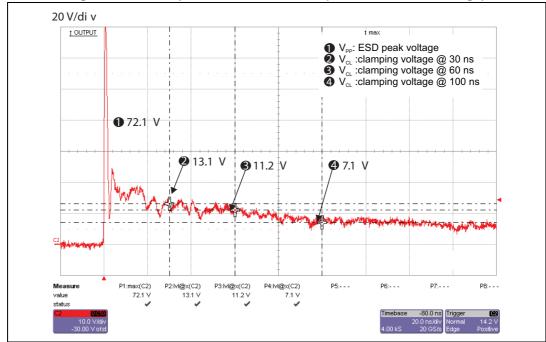


Figure 4. Common mode attenuation versus frequency ( $Z_{0 \text{ com}} = 50 \Omega$ )





Characteristics ECMF04-4HSWM10

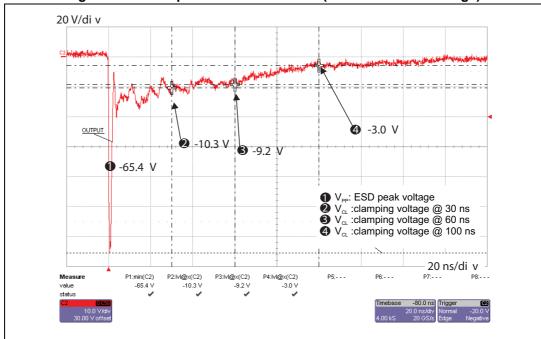
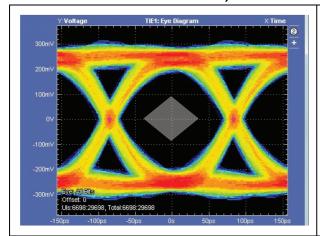
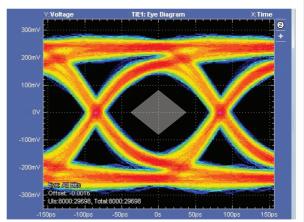


Figure 6. ESD response to IEC61000-4-2 (-8 kV contact discharge)

Figure 7. HDMI2.0 5.94 Gbps eye diagram without ECMF04-4HSWM10 (evaluation board with SMA connector)

Figure 8. HDMI2.0 5.94 Gbps eye diagram with ECMF04-4HSWM10 (evaluation board with SMA connector)



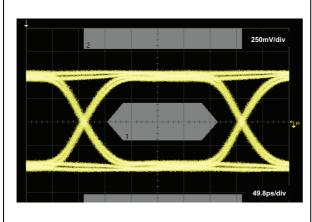


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ECMF04-4HSWM10 Characteristics

Figure 9. HDMI1.4 3.35 Gbps eye diagram without ECMF04-4HSWM10

Figure 10. HDMI1.4 3.35 Gbps eye diagram with ECMF04-4HSWM10



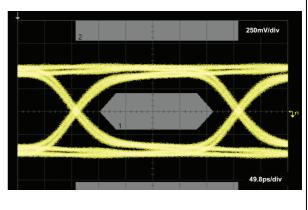
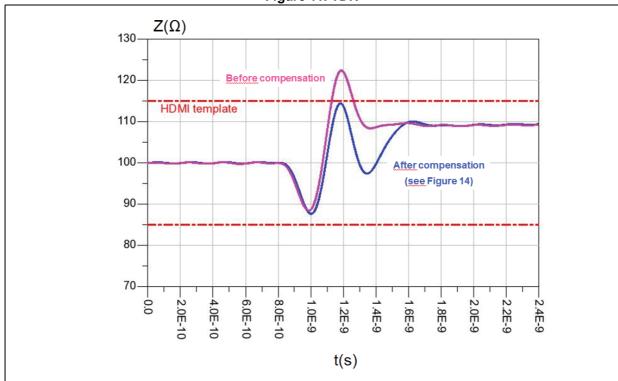


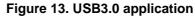
Figure 11. TDR

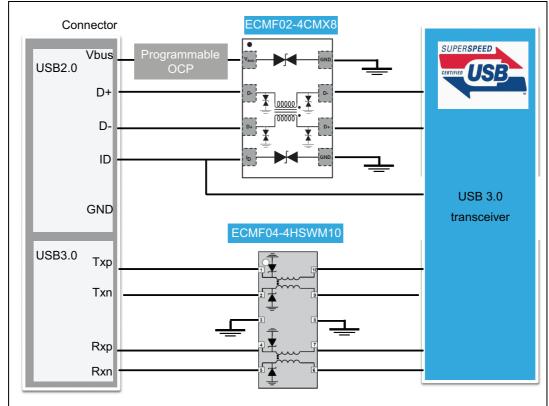


#### **Application information** 2

ECMF04 ECMF04 HDMI2C1-6C1

Figure 12. HDMI schematic



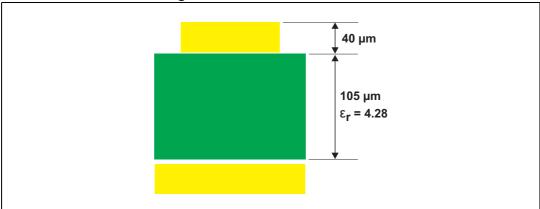


#### **PCB** layout recommendations 3

Connector Host 5000 μm 350 µm 350 µm lanes  $(Z_0 = 100 \Omega)$  $(Z_0 = 100 \Omega)$ 

Figure 14. PCB layout recommendations







Package information ECMF04-4HSWM10

# 4 Package information

- Epoxy meets UL94, V0
- Lead-free package

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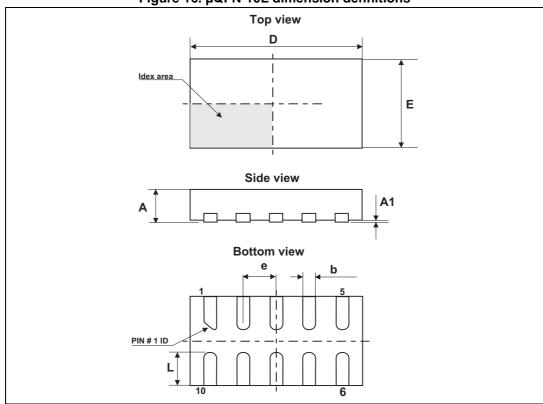


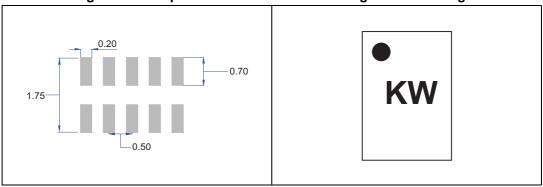
Figure 16. µQFN-10L dimension definitions

Table 4. µQFN-10L dimension values

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.45	0.50	0.55	0.018	0.020	0.022	
A1	0.00	0.02	0.05	0.00	0.0008	0.002	
b	0.15	0.20	0.25	0.006	0.008	0.010	
D	2.55	2.60	2.65	0.1	0.102	0.104	
Е	1.30	1.35	1.40	0.051	0.053	0.055	
е		0.50			0.020		
L	0.40	0.50	0.60	0.016	0.020	0.024	

Figure 17. Footprint

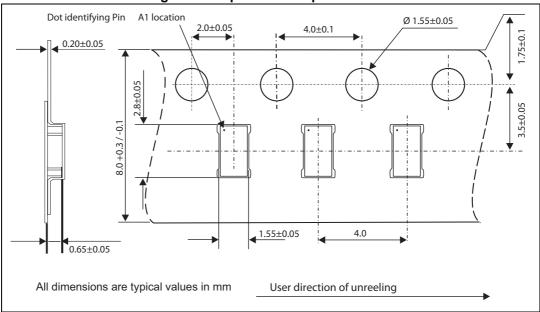
Figure 18. Marking



Note:

Product marking may be rotated by multiples of 90° for assembly plant differentiation. In no case should this product marking be used to orient the component for its placement on a PCB. Only pin 1 mark is to be used for this purpose.

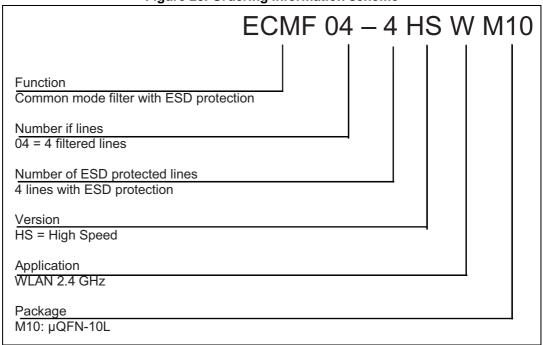
Figure 19. Tape and reel specifications



Ordering information ECMF04-4HSWM10

### 5 Ordering information

Figure 20. Ordering information scheme



**Table 5. Ordering information** 

Order code	Marking <sup>(1)</sup>	Package	Weight	Base qty	Delivery mode
ECMF04-4HSWM10	KW	μQFN-10L	5.00 mg	3000	Tape and reel

<sup>1.</sup> The marking can be rotated by multiples of  $90^\circ$  to differentiate assembly location

### 6 Revision history

Table 6. Document revision history

Date	Revision	Changes
10-Jun-2014	1	Initial release.

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